DESCRIPTION: 56-contact, Thin Fine Pitch Quad Flat No-lead (TQFN)

PACKAGE CODE: ZF56

DOCUMENT CONTROL #: PD-2024

REVISION: C

DATE: 05/15/08

NOTE:
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
3. REFER JEDEC MO-220 MODIFIED.
4. Thermal Via Diameter. Recommended 0.2~0.33mm
5. Thermal Via Pitch. Recommended 1.27mm

Recommended Land Pattern